

**Declaration for Patent Application**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first or joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: **ANTI-FREEZING AND DEICING COMPOSITION AND METHOD**

the specification of which

[X] is attached hereto

[ ] was filed on N/A as Application Serial No. N/A and was amended on N/A (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination, including patentability of this application in accordance with Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 (a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate, or §365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below, any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed:

			<u>PRIORITY</u>
(Number)	(Country)	(Day/Month/Year Filed)	[ ] Yes [ ] No

I hereby claim the benefit under 35 USC § 119(e) of any United States provisional application(s) listed below.

<u>60/121,389</u> (Application Serial No.)	<u>February 24, 1999</u> (Filing Date)
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I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s), or § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §

1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

(Application Serial No.)

(Filing Date)

(Status)

I hereby declare that all statements made herein of my own knowledge are true, and that all statements made on information and belief are believed to be true; and further, that these statements were made with the knowledge that willful false statements and the like, so made, are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

And I hereby appoint J. Ralph King, Registration No. 22,489; Warren D. Schickli, Registration No. 31,057; Michael S. Hargis, Registration No. 42,631; Andrew D. Dorisio, Registration No. 41,713; J. William Seanor, DVM, Registration No. 40,804 of **KING AND SCHICKLI**, Corporate Gateway, Suite 210, 3070 Harrodsburg Road, Lexington, KY 40503, my attorneys with full power of substitution and revocation, to prosecute this application and to transact all business in the United States Patent and Trademark Office connected herewith.

Please address all correspondence to: **KING AND SCHICKLI**, Corporate Gateway, Suite 210, 3070 Harrodsburg Road, Lexington, KY 40503.

Full name of sole or first inventor: **Todd A. Bloomer**

Inventor's signature: Todd A. Bloomer Date 6/9/99

Residence: **108 Parker Place, Georgetown, Kentucky 40324**

Citizenship: **U.S.**

Post Office Address: